

General Description

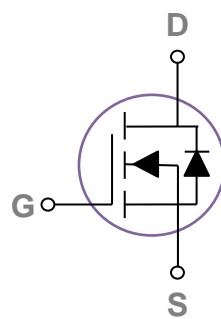
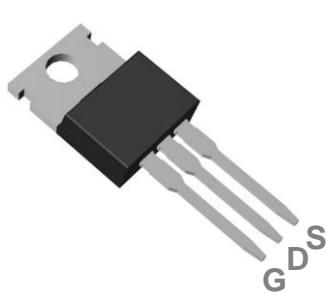
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

| BVDSS | RDS(ON) | ID |
|-------|---------|------|
| 200V | 9.3mΩ | 100A |

Features

- 200V,100A, RDS(ON) =9.3mΩ @VGS = 10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

TO220 Pin Configuration



Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|-----------|--|------------|-------|
| V_{DS} | Drain-Source Voltage | 200 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current – Continuous ($T_c=25^\circ\text{C}$) | 100 | A |
| | Drain Current – Continuous ($T_c=100^\circ\text{C}$) | 64 | A |
| I_{DM} | Drain Current – Pulsed ¹ | 400 | A |
| EAS | Single Pulse Avalanche Energy ² | 2048 | mJ |
| IAS | Single Pulse Avalanche Current ² | 64 | A |
| P_D | Power Dissipation ($T_c=25^\circ\text{C}$) | 305 | W |
| | Power Dissipation – Derate above 25°C | 2.44 | W/°C |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | --- | 62 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | --- | 0.41 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)
Off Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------------------------|--------------------------------|--|------|------|-----------|---------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$ | 200 | --- | --- | V |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=200\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | μA |
| | | $V_{\text{DS}}=160\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=85^\circ\text{C}$ | --- | --- | 10 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |

On Characteristics

| | | | | | | |
|---------------------|-----------------------------------|--|-----|-----|-----|------------------|
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{\text{GS}}=10\text{V}$, $I_D=40\text{A}$ | --- | 7.7 | 9.3 | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$ | 2.5 | 3.5 | 4.5 | V |

Dynamic and switching Characteristics³

| | | | | | | |
|---------------------|------------------------------|--|-----|------|-------|----------|
| Q_g | Total Gate Charge | $V_{\text{DS}}=100\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=50\text{A}$ | --- | 125 | 190 | nC |
| Q_{gs} | Gate-Source Charge | | --- | 28 | 45 | |
| Q_{gd} | Gate-Drain Charge | | --- | 36 | 55 | |
| $T_{\text{d(on)}}$ | Turn-On Delay Time | $V_{\text{DD}}=100\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=6\Omega$ $I_D=50\text{A}$ | --- | 20 | 30 | ns |
| T_r | Rise Time | | --- | 30 | 45 | |
| $T_{\text{d(off)}}$ | Turn-Off Delay Time | | --- | 30 | 45 | |
| T_f | Fall Time | | --- | 45 | 70 | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=100\text{V}$, $V_{\text{GS}}=0\text{V}$, $F=1\text{MHz}$ | --- | 6950 | 10500 | pF |
| C_{oss} | Output Capacitance | | --- | 500 | 750 | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 24 | 40 | |
| R_g | Gate Resistance | $V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $F=1\text{MHz}$ | --- | 1.6 | --- | Ω |

Guaranteed Avalanche Energy

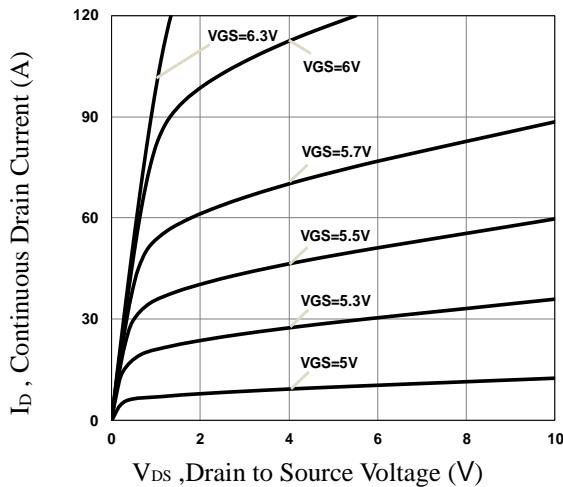
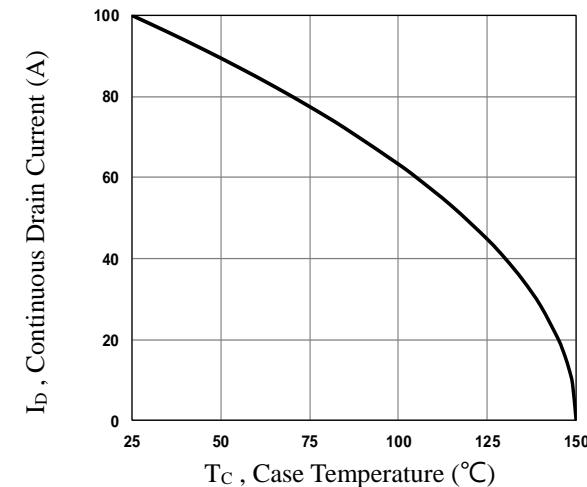
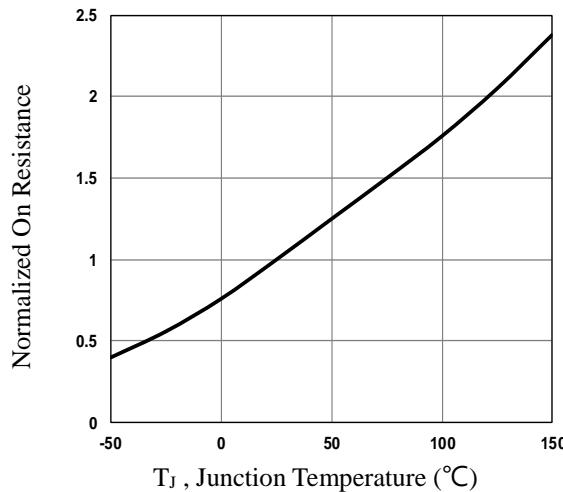
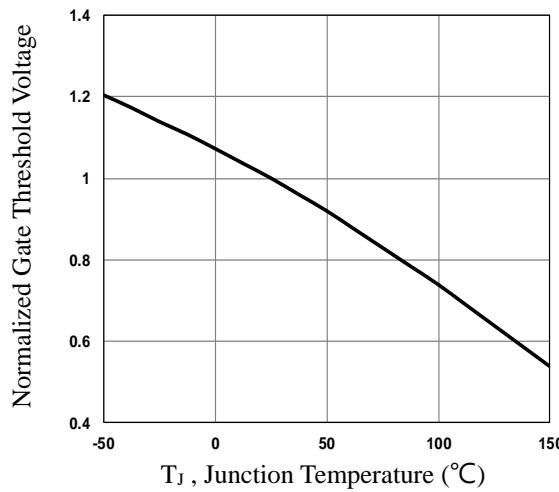
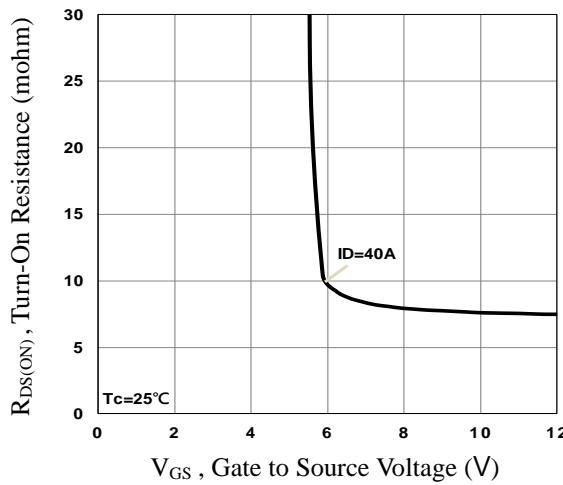
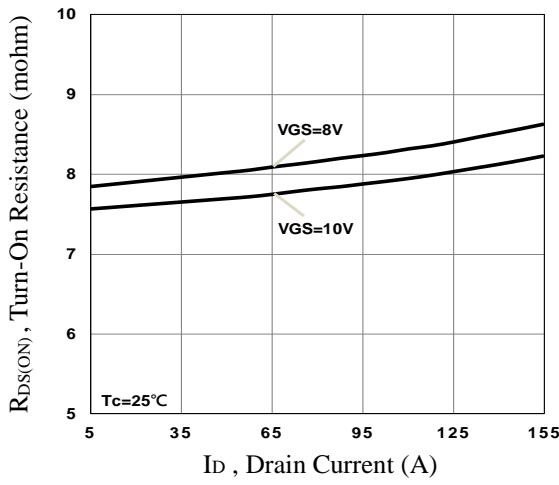
| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|-------------------------------|--|------|------|------|-------------|
| EAS | Single Pulse Avalanche Energy | $V_{\text{DD}}=50\text{V}$, $L=1\text{mH}$, $I_{\text{AS}}=45\text{A}$ | 1012 | --- | --- | mJ |

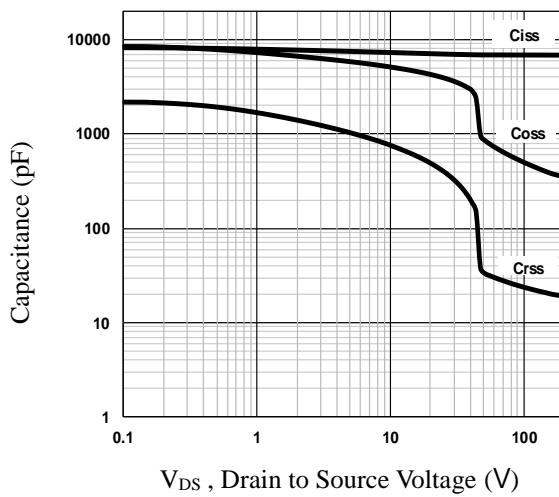
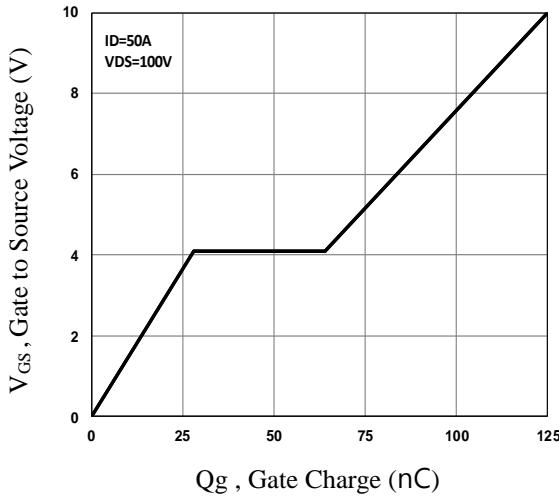
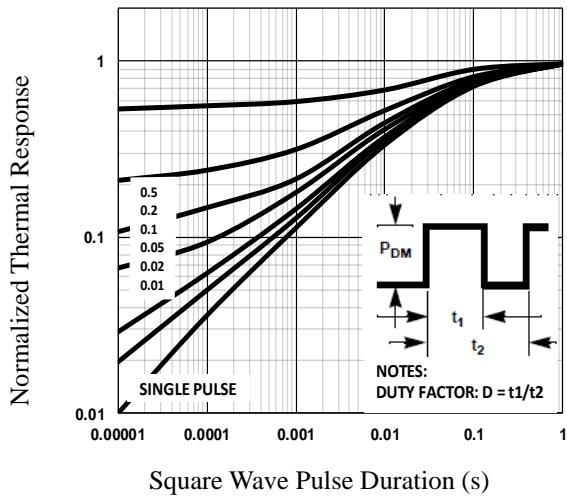
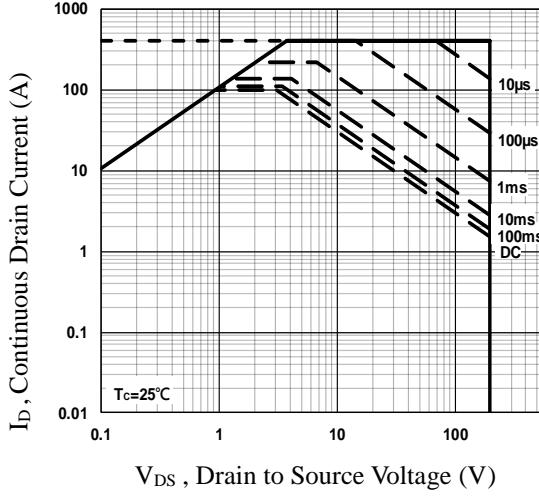
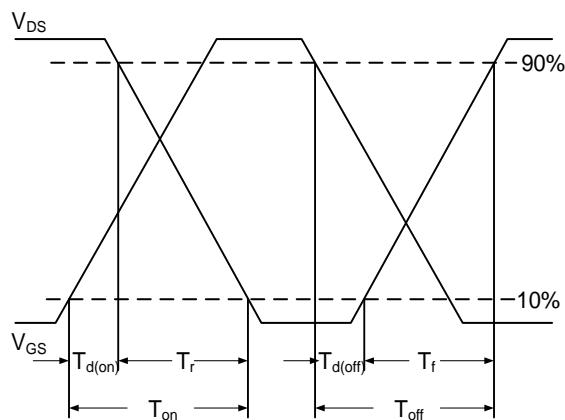
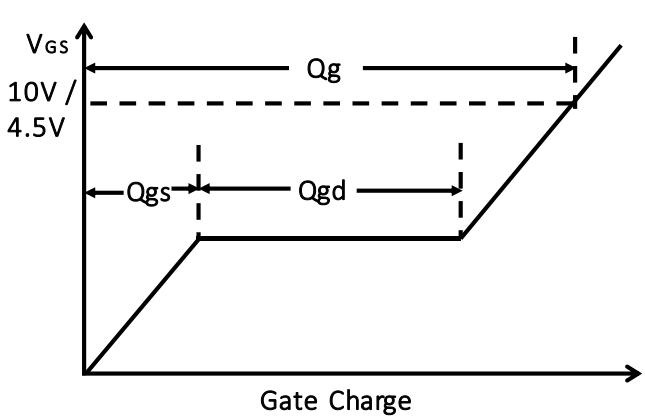
Drain-Source Diode Characteristics and Maximum Ratings

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|---------------------------|--|------|------|------|------|
| I_s | Continuous Source Current | $V_G=V_D=0\text{V}$, Force Current | --- | --- | 100 | A |
| I_{SM} | Pulsed Source Current | | --- | --- | 200 | A |
| V_{SD} | Diode Forward Voltage | $V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | V |
| t_{rr} | Reverse Recovery Time | $V_R=100\text{V}$, $I_s=10\text{A}$ | --- | 130 | --- | ns |
| Q_{rr} | Reverse Recovery Charge | $di/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$ | --- | 710 | --- | nC |

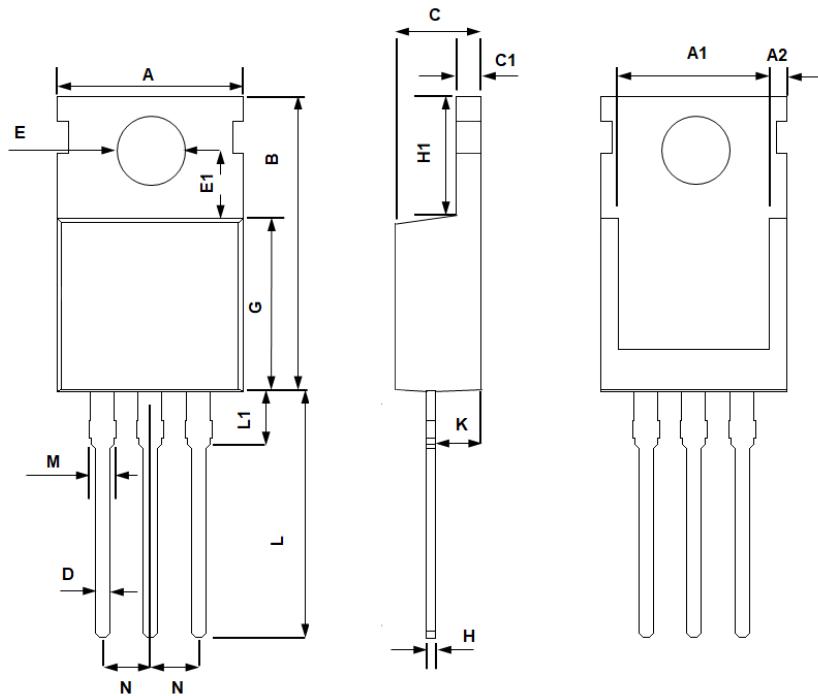
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=1\text{mH}$, $I_{\text{AS}}=64\text{A}$, $R_g=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. Essentially independent of operating temperature.


Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized $R_{DS(on)}$ vs. T_j

Fig.4 Normalized V_{th} vs. T_j

Fig.5 Turn-On Resistance vs. V_{GS}

Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 Gate Charge Waveform

TO220 PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | MAX | MIN | MAX | MIN |
| A | 10.400 | 9.700 | 0.409 | 0.382 |
| A1 | 8.900 | 7.400 | 0.350 | 0.291 |
| A2 | 1.400 | 0.800 | 0.055 | 0.031 |
| B | 16.500 | 14.500 | 0.650 | 0.571 |
| C | 4.750 | 4.200 | 0.187 | 0.165 |
| C1 | 1.500 | 1.100 | 0.059 | 0.043 |
| D | 1.000 | 0.600 | 0.039 | 0.024 |
| E | 4.000 | 3.300 | 0.157 | 0.130 |
| E1 | 3.800 | 3.400 | 0.150 | 0.134 |
| G | 9.400 | 8.400 | 0.370 | 0.331 |
| H | 0.600 | 0.200 | 0.024 | 0.008 |
| H1 | 6.850 | 6.200 | 0.270 | 0.244 |
| K | 2.850 | 2.100 | 0.112 | 0.083 |
| L | 14.000 | 12.500 | 0.551 | 0.492 |
| L1 | 4.000 | 2.700 | 0.157 | 0.106 |
| M | 1.750 | 1.100 | 0.069 | 0.043 |
| N | 2.640 | 2.440 | 0.104 | 0.096 |